

# N-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY										
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A) <sup>b, c</sup>	Q <sub>g</sub> (Typ.)							
20	0.0135 at V <sub>GS</sub> = 10 V	12 <sup>a</sup>	5.3 nC							
20	0.0185 at V <sub>GS</sub> = 4.5 V	10.8	3.5110							

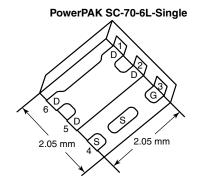
### **FEATURES**

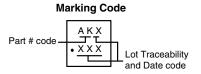
- TrenchFET® Power MOSFET
- Thermally Enhanced PowerPAK® SC-70 Package
  - Small Footprint Area
- · Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



### **APPLICATIONS**

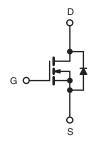
· Load Switch





#### Ordering Information:

SiA430DJ-T1-GE3 (Lead (Pb)-free and Halogen-free) SiA430DJ-T4-GE3 (Lead (Pb)-free and Halogen-free)



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<b>ABSOLUTE MAXIMUM RATIN</b>	IGS (T <sub>A</sub> = 25 °C	, unless oth	erwise noted)		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		$V_{DS}$	20	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20	V	
	T <sub>C</sub> = 25 °C		12 <sup>a</sup>		
Continuous Drain Current (T <sub>.1</sub> = 150 °C)	T <sub>C</sub> = 70 °C	1	12 <sup>a</sup>		
Continuous Diain Current (1) = 150 C)	T <sub>A</sub> = 25 °C	l <sub>D</sub>	12 <sup>a, b, c</sup>		
	T <sub>A</sub> = 70 °C		10.1 <sup>b, c</sup>	Α	
Pulsed Drain Current		I <sub>DM</sub>	40		
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C		12 <sup>a</sup>		
Continuous Source-Diam Diode Current	T <sub>A</sub> = 25 °C	Is	2.9 <sup>b, c</sup>		
	T <sub>C</sub> = 25 °C		19.2		
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	P <sub>D</sub>	12.3	w	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	] 'D	3.5 <sup>b, c</sup>	VV	
	T <sub>A</sub> = 70 °C	1	2.2 <sup>b, c</sup>		
Operating Junction and Storage Temperatur	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		
Soldering Recommendations (Peak Temper	ature) <sup>d, e</sup>		260		

THERMAL RESISTANCE RATINGS									
Parameter		Symbol	Typical	Maximum	Unit				
Maximum Junction-to-Ambient <sup>b, f</sup>	t ≤ 5 s	$R_{thJA}$	28	36	°C/W				
Maximum Junction-to-Case (Drain)	Steady State	$R_{thJC}$	5.3	6.5	C/VV				

#### Notes:

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 5 s.
- d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under steady state conditions is 80 °C/W.

Document Number: 68685 S13-0116-Rev. B, 21-Jan-13 For technical questions, contact: pmostechsupport@vishav.com



<b>SPECIFICATIONS</b> ( $T_J = 25  ^{\circ}C$ , Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static		1001 00110110		.,,,,		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	20			٧
V <sub>DS</sub> Temperature Coefficient	ΔV <sub>DS</sub> /T <sub>J</sub>			24		mV/°C
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	- I <sub>D</sub> = 250 μA		- 5.6		
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_{D} = 250 \mu\text{A}$	1		3	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
		V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V			1	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			10	μΑ
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			Α
	_	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 7 A		0.0108	0.0135	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 5 \text{ A}$		0.0146	0.0185	Ω
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 7 A		16		S
Dynamic <sup>b</sup>				L	l	
Input Capacitance	C <sub>iss</sub>			800		pF
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		200		
Reverse Transfer Capacitance	C <sub>rss</sub>			90		
Total Cata Charga		$V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 12 \text{ A}$		12	18	nC
Total Gate Charge	$Q_g$			5.3	9	
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 12 \text{ A}$		2		
Gate-Drain Charge	Q <sub>gd</sub>			1.4		
Gate Resistance	$R_{g}$	f = 1 MHz		2.5		Ω
Turn-On Delay Time	t <sub>d(on)</sub>			16	25	- ns
Rise Time	t <sub>r</sub>	$V_{DD} = 10 \text{ V}, R_{I} = 1 \Omega$		10	15	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		15	25	
Fall Time	t <sub>f</sub>	D - ALIN - A		10	15	
Turn-On Delay Time	t <sub>d(on)</sub>			10	15	113
Rise Time	t <sub>r</sub>	$V_{DD} = 10 \text{ V}, R_{I} = 1 \Omega$		8	15	- - -
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_{D} \cong 10 \text{ A}, \ V_{GEN} = 10 \text{ V}, \ R_{q} = 1 \Omega$		17	30	
Fall Time	t <sub>f</sub>	- D - 1919 GEN 1919 19		8	15	
Drain-Source Body Diode Characteristic	s					
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			12	Α
Pulse Diode Forward Current I <sub>SM</sub>					40	
Body Diode Voltage	$V_{SD}$	$I_S = 5 A, V_{GS} = 0 V$		0.8	1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			18	30	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = 10 A, dl/dt = 100 A/μs, T <sub>.I</sub> = 25 °C		7	15	nC
Reverse Recovery Fall Time	t <sub>a</sub>	1- 10 Λ, αναι – 100 Λ/μο, 1j – 25 °C		8		nc
Reverse Recovery Rise Time	t <sub>b</sub>			10		ns

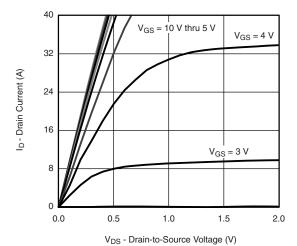
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.

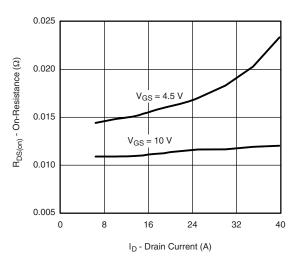
b. Guaranteed by design, not subject to production testing.



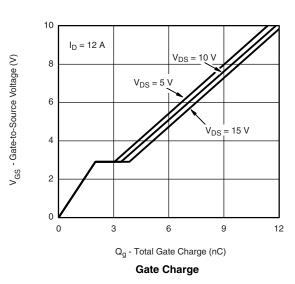
## TYPICAL CHARACTERISTIC (25 °C, unless otherwise noted)

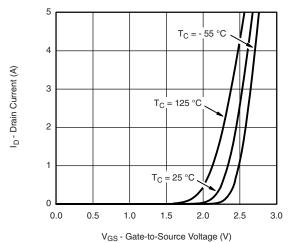


### **Output Characteristics**

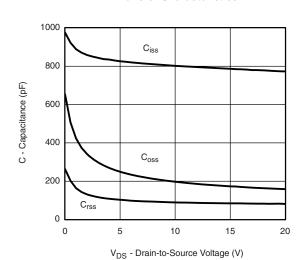


### On-Resistance vs. Drain Current and Gate Voltage

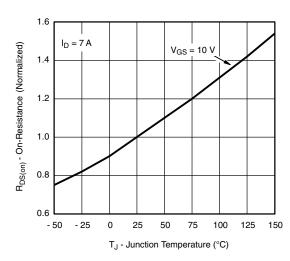




**Transfer Characteristics** 

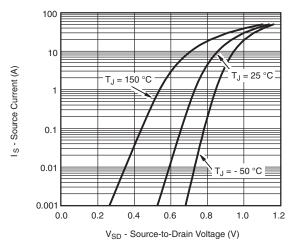


Capacitance

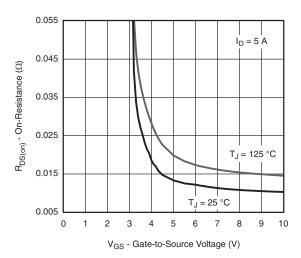


On-Resistance vs. Junction Temperature

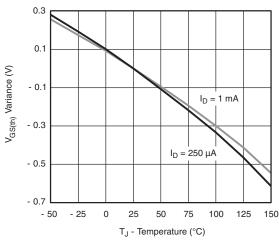
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



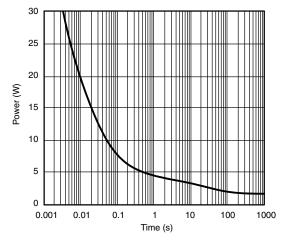
Source-Drain Diode Forward Voltage



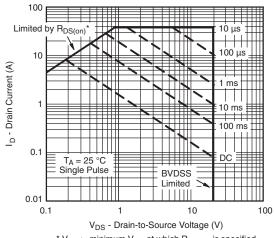
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 



Single Pulse Power (Junction-to-Ambient)



\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

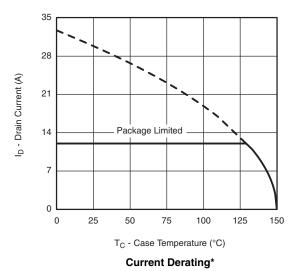
Safe Operating Area, Junction-to-Ambient

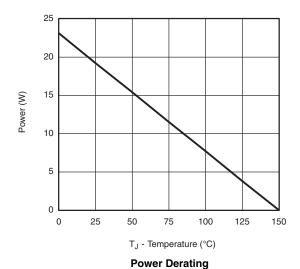






## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

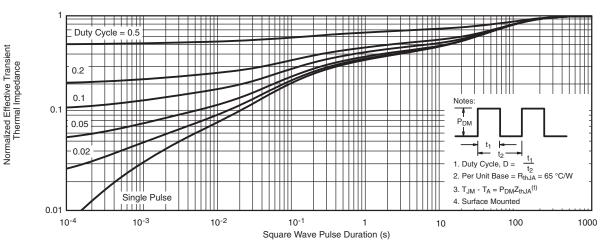




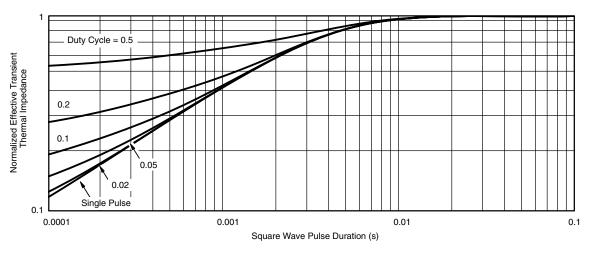
 $<sup>^{\</sup>star}$  The power dissipation  $P_D$  is based on  $T_{J(max.)}$  = 150  $^{\circ}$ C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?68685.

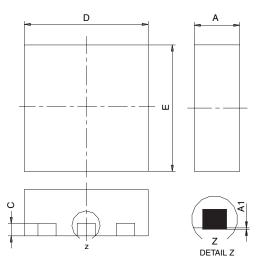
## PowerPAK® SC70-6L





BACKSIDE VIEW OF SINGLE

BACKSIDE VIEW OF DUAL



- All dimensions are in millimeters
  Package outline exclusive of mold flash and metal burr
  Package outline inclusive of plating

	SINGLE PAD						DUAL PAD					
DIM	M	ILLIMETER	RS		INCHES		MILLIMETERS			INCHES		
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max
Α	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032
A1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002
b	0.23	0.30	0.38	0.009	0.012	0.015	0.23	0.30	0.38	0.009	0.012	0.015
С	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010
D	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
D1	0.85	0.95	1.05	0.033	0.037	0.041	0.513	0.613	0.713	0.020	0.024	0.028
D2	0.135	0.235	0.335	0.005	0.009	0.013						
E	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
E1	1.40	1.50	1.60	0.055	0.059	0.063	0.85	0.95	1.05	0.033	0.037	0.041
E2	0.345	0.395	0.445	0.014	0.016	0.018						
E3	0.425	0.475	0.525	0.017	0.019	0.021						
е		0.65 BSC			0.026 BSC	;	0.65 BSC			0.026 BSC		
K		0.275 TYP			0.011 TYP	1	0.275 TYP			0.011 TYP		
K1		0.400 TYP			0.016 TYP	1	0.320 TYP			0.013 TYP		
K2		0.240 TYP			0.009 TYP		0.252 TYP		0.010 TYP			
К3		0.225 TYP	1	0.009 TYP								
K4		0.355 TYP			0.014 TYP							
L	0.175	0.275	0.375	0.007	0.011	0.015	0.175	0.275	0.375	0.007	0.011	0.015
Т							0.05	0.10	0.15	0.002	0.004	0.006
FCN: C-07431 - Bey. C. 06-Aug-07												

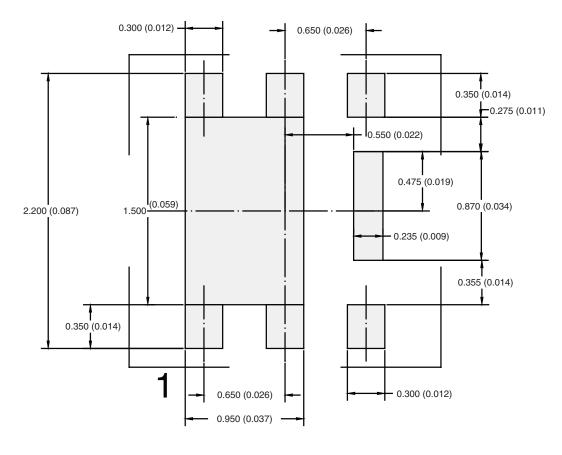
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Document Number: 73001 06-Aug-07

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## RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Single



Dimensions in mm/(Inches)

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ATTLICATION NOT



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